L Number	Hits	Search Text	DB	Time stamp
3	36	438/705 and sacrificial	USPAT;	2004/03/19 15:35
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT,	
			IBM_TDB	
4	26441	etch\$ adj2 (rate? time selectivity)	USPAT;	2004/03/19 14:01
			US-PGPUB;	
	7 4 4 1 24 4	A 40 11 1 2	EPO; JPO;	
			DERWENT,	
,	0/7	(-4-1-0 - 1/2 (-4-0 4/14//t-))	IBM_TDB	2004/03/19 13:54
5	867	(etch\$ adj2 (rate? time selectivity)) same mask?	USPAT; US-PGPUB;	2004/03/19 13.34
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
6	16	((etch\$ adj2 (rate? time selectivity)) same mask?) same sacrificial	USPAT;	2004/03/19 13:54
			US-PGPUB;	
			EPO; JPO;	
			DERWENT,	
			IBM_TDB	
7	3808	etch\$ adj rate? with (different high\$2 low\$2)	USPAT;	2004/03/19 14:36
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
		4 . 4 4 4 6 24 4400 4111401 (00)	IBM_TDB	2004/02/10 14 00
8	135	(etch\$ adj rate? with (different high\$2 low\$2)) and stack?	USPAT;	2004/03/19 14:08
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT; IBM_TDB	
9	12	((etch\$ adj rate? with (different high\$2 low\$2)) and stack?) and	USPAT;	2004/03/19 14:03
,	12	semiconductor?	US-PGPUB;	200 1/03/17 11:03
		Scilliotitudeoi :	ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
10	161	(etch\$ adj rate? with (different high\$2 low\$2)) same simultaneous\$2	USPAT;	2004/03/19 14:09
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
		(( ) 1	IBM_TDB	2004/02/10 14:20
11	45		USPAT; US-PGPUB;	2004/03/19 14:20
		same layer?	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
12	2803	(438/745,750,751-752,705,707,710,714,604-606).CCLS.	USPAT	2004/03/19 14:21
13	28	etch\$ adj rate? with different with simultaneous\$2	USPAT;	2004/03/19 15:39
		•	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
14	927		USPAT	2004/03/19 15:37
15	307	((438/735-739).CCLS.) and protect\$4 with etch\$3	USPAT;	2004/03/19 15:41
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
16	12	((438/735-739).CCLS.) and protect\$4 with etch\$3 same etch\$3 near5	IBM_TDB USPAT;	2004/03/19 15:42
16	12	rate?	US-PGPUB;	2007103117 13.42
		inc:	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	L	l		L